onsemi

MOSFET – N-Channel, POWERTRENCH[®]

100 V, 75 A, 9 m Ω

FDP090N10

Description

This N-Channel MOSFET is produced using **onsemi**'s advance POWERTRENCH process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Features

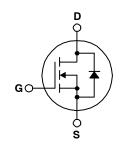
- $R_{DS(on)} = 7.2 \text{ m}\Omega \text{ (Typ)} @ V_{GS} = 10 \text{ V}, I_D = 75 \text{ A}$
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low R_{DS(on)}
- High Power and Current Handling Capability
- RoHS Compliant

Applications

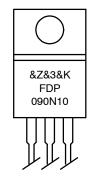
- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies
- Micor Solar Inverter

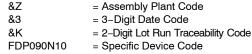


TO-220-3LD CASE 340AT



MARKING DIAGRAM





ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

MOSFET MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Symbol		FDP090N10	Unit	
V _{DSS}	Drain to Source Voltage		100	V
V _{GSS}	Gate to Source Voltage	Gate to Source Voltage		V
Ι _D	Drain Current	– Continuous $T_C = 85^{\circ}C$	75	Α
I _{DM}	Drain Current	– Pulsed (Note 1)	300	Α
E _{AS}	Single Pulse Avalanche Energ	309	mJ	
I _{AR}	Avalanche Current (Note 1)		75	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		20.8	mJ
dv/dt	Peak Diode Recovery dv/dt (N	Peak Diode Recovery dv/dt (Note 3)		V/ns
PD	Power Dissipation	$T_{C} = 25^{\circ}C$	208	W
		– Derate Above 25°C	1.39	W/°C
T _J , T _{STG}	Operating and Storage Junctio	Operating and Storage Junction Temperature Range		
ΤL	Maximum Lead Temperature for	or Soldering, 1/8" from Case for 5 Seconds	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter	FDP090N10	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max	0.72	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max	62.5	

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
OFF CHAF	ACTERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	I_D = 250 $\mu A,V_{GS}$ = 0 V, T_C = 25°C	100	-	-	V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25° C	-	0.1	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 100 V, V _{GS} = 0 V	-	-	1	μΑ
		V_{DS} = 100 V, V_{GS} = 0 V, T_{C} = 150°C	-	-	500	
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20$ V, $V_{DS} = 0$ V	-	-	±100	nA
ON CHAR	ACTERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	2.5	3.5	4.5	V
				1		

mΩ S

V _{GS(th)}	Gate Threshold Voltage	V_{GS} = V_{DS} , I_D = 250 μ A	2.5	3.5	4.5
R _{DS(on)}	Static Drain to Source On Resistance	V_{GS} = 10 V, I _D = 75 A	-	7.2	9
9 FS	Forward Transconductance	V_{DS} = 10 V, I _D = 37.5 A	-	100	-

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted) (continued)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit	
DYNAMIC CHARACTERISTICS							
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1 MHz	-	6185	8225	pF	
C _{oss}	Output Capacitance		-	585	775	pF	
C _{rss}	Reverse Transfer Capacitance		-	235	355	pF	
SWITCHIN	SWITCHING CHARACTERISTICS						

t _{d(on)}	Turn–On Delay Time	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 75 \text{ A},$	-	107	224	ns
t _r	Turn–On Rise Time	V_{GS} = 10 V, R_{G} = 25 Ω (Note 4)	-	322	655	
t _{d(off)}	Turn-Off Delay Time]	-	166	342	
t _f	Turn-Off Fall Time]	-	149	309	
Q _{g(TOT)}	Total Gate Charge at 10 V	V_{DS} = 50 V, I_{D} = 75 A V_{GS} = 10 V (Note 4)	-	89	116	nC
Q _{gs}	Gate to Source Gate Charge		-	37	-	
Q _{gd}	Gate to Drain "Miller" Charge]	-	22	-	

DRAIN-SOURE DIODE CHARACTERISTICS

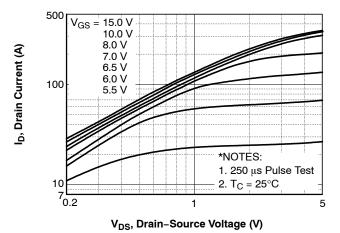
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	75	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	300	А
V _{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 75 \text{ A}$	-	-	1.25	V
t _{rr}	Reverse Recovery Time	V_{GS} = 0 V, I_{SD} = 75 A, dI_F/dt = 100 A/ μs	-	73	-	ns
Q _{rr}	Reverse Recovery Charge		-	166	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NOTES:

1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. L = 0.11 mH, $I_{AS} = 75 \text{ A}$, $V_{DD} = 50 \text{ V}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \le 75 \text{ A}$, di/dt $\le 200 \text{ A}/\mu\text{s}$, $V_{DD} \le BV_{DSS}$, starting $T_J = 25^{\circ}\text{C}$. 4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS





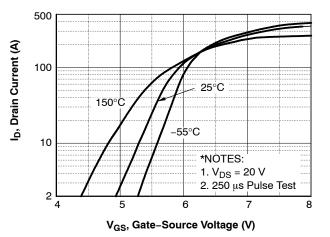
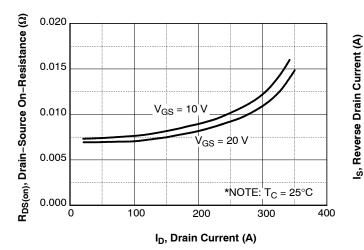
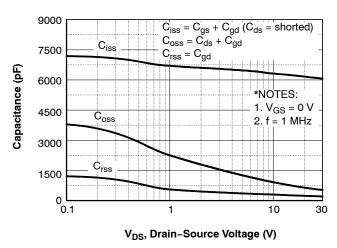


Figure 2. Transfer Characteristics









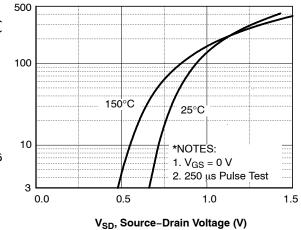


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

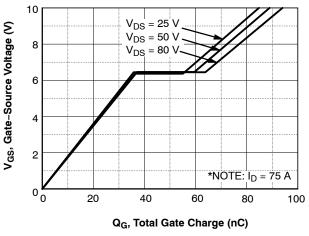
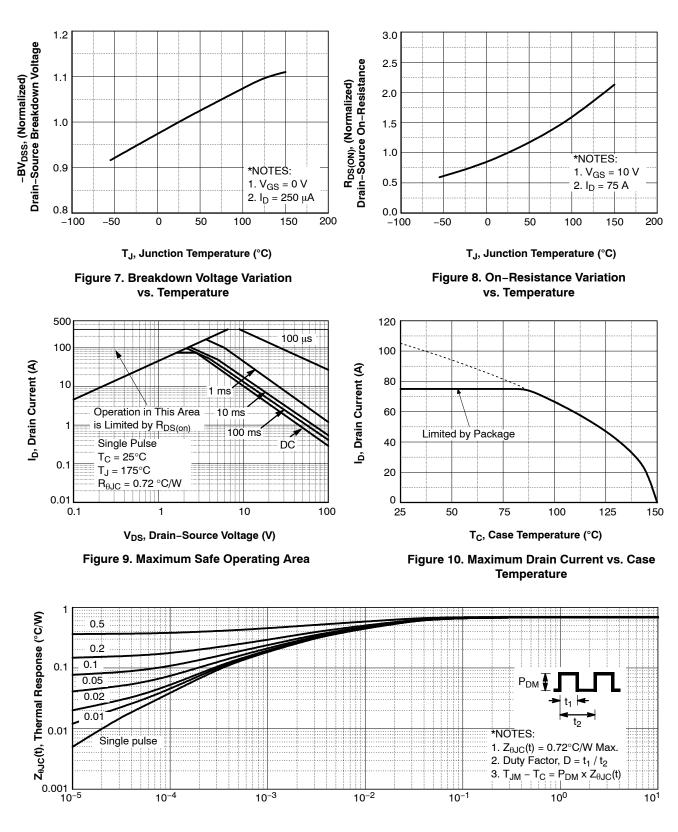


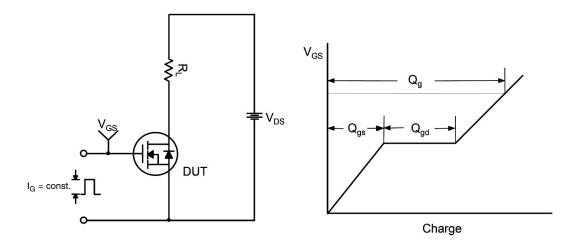
Figure 6. Gate Charge Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (continued)





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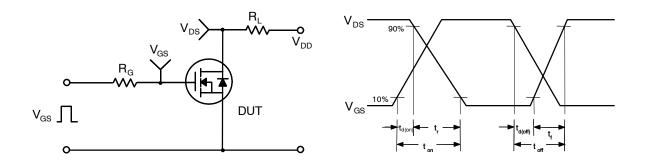


Figure 13. Resistive Switching Test Circuit & Waveforms

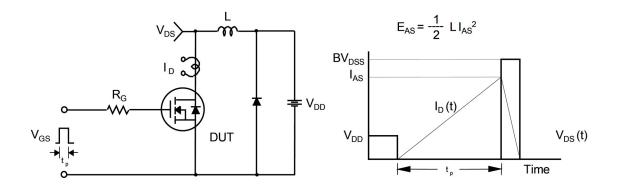


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

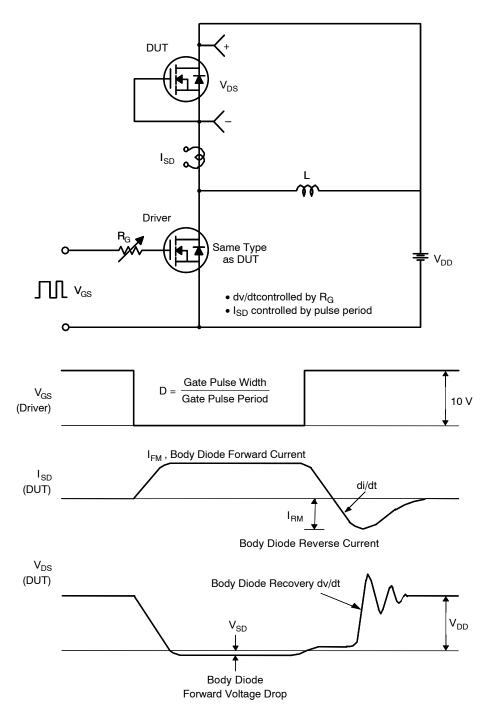


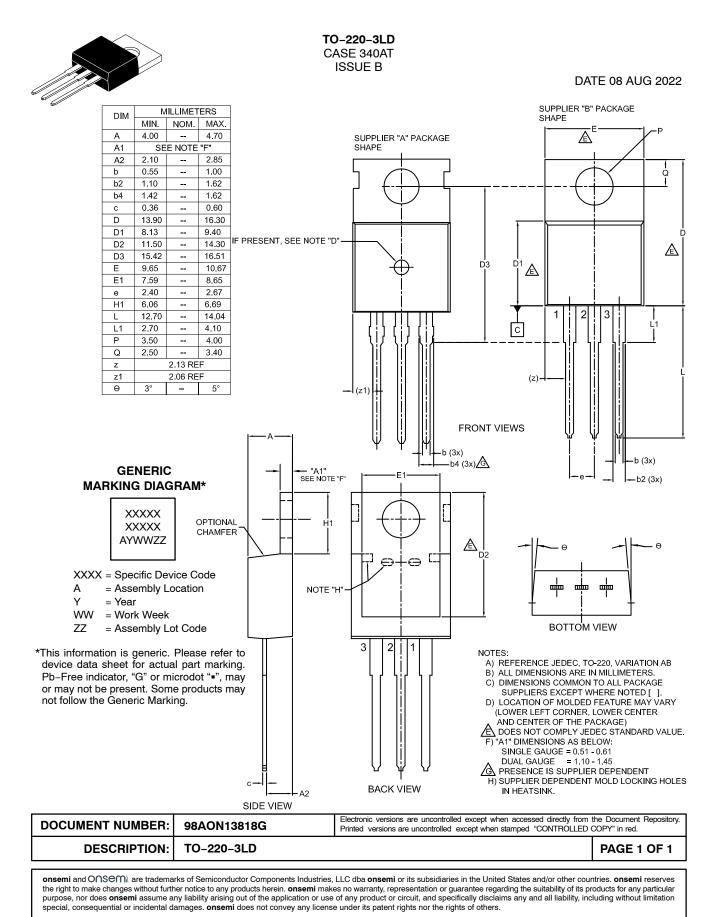
Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping
FDP090N10	FDP090N10	TO-220	800 Units / Tube

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